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U.S. DEPARTMENT OF COMMERCE
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To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies):

Satoshi Ikeda (11/21/2005) and Masayuki Yamamoto (11/21/2005)

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: Nitto Denko Corporation

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JAPAN

City:

State:

Country: Zip:

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance/Execution Date(s):

Execution Date(s): in parentheses after inventor name

Assignment Merger Change of Name

Security Agreement Joint Research Agreement

Government Interest Assignment

Executive Order 9424, Confirmatory License

Other

4. Application or patent number(s):

This document is being filed together with a new application.

A. Patent Application No.(s)

This application

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:

Name: David T. Nikaido
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6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers
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b. Deposit Account Number 18-0013
Authorized User Name David T. Nikaido

9. Signature:

[Handwritten Signature] 47,255

Signature

December 8, 2005

Date

David T. Nikaido - 22,663

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

12/14/2005 ECDOPER 00000021 180013 11296276

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40.00 DA

Docket No. _____

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00)), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

NITTO DENKO CORPORATION whose address is 1-2, Shimohozumi 1-chome, Ibaraki-shi,
Osaka 567-8680 JAPAN

[Insert
ASSIGNEE's
Name(s)
Address(es)]

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

Semiconductor Wafer Positioning Method, and Apparatus Using the Same

[Title of
Invention]

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

[*If the assignment
is being filed
after the filing of the
application, this
section must be
completed]

*filed on _____, Serial No. _____

(Rader, Fishman & Grauer, PLLC is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with application and any continuing' divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, division, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

[Signature(s)
of Assignor(s)]

<u>Satoshi Ikeda</u> (SIGNATURE)	<u>Satoshi IKEDA</u> (TYPE NAME)	<u>21/11/2005</u> (DATE)
<u>Masayuki Yamamoto</u> (SIGNATURE)	<u>Masayuki YAMAMOTO</u> (TYPE NAME)	<u>21/11/2005</u> (DATE)
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_____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
_____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)